| | | | | | | | Frron |
|--------------|---------|-------|--|--|------------------|---|------------|
| | E GO | Hits | Search Text | DBs | Time Stamp | Comments | Definition |
| | 27 | ن ا | Thosisto with outdassing | USPAT; US-PGPUB; EPO; | 2001/11/28 18:44 | | |
| | BRS | Lyb | | | 0 | | |
| 2 | BRS | м | ((solder adj mask) with out\$1gass\$3) | DERWENT; IBM | • ; | | |
| <u></u> | BRS | 165 | solder same out\$1gass\$3 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/28 19:22 | | |
| 4 | BRS | 10 | ((solder adj mask) same out\$1gass\$3) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/28 18:52 | | |
| <u> </u> | BRS | 73 | (solder same out\$1gass\$3) and adhesive | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/28 19:21 | | |
| <u> </u> | BRS | 24 | (solder with out\$1gass\$3) and adhesive | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/28 19:22 | | |
| | BRS | 850 | (solder adj mask) and (adhesive or | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/29 13:19 | | |
| _ ∞ | BRS | 285 | (solder adj mask) same (adhesive or | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/29 13:24 | *************************************** | |
| 0 | BRS | 162 | ((solder adj mask) same (adhesive or | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/29 13:21 | | |
| | | 9 | lask) same bi | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/29 13:41 | | |
| | $\neg $ | | adj mask) and ((bismaleimide or bt) | | 2001/11/29 13:44 | | |
| | l BRS | 4. | with adhesive) | | 2001/11/29 13:45 | *************************************** | |
| 12 | 2 IS&R | T | 94").PN. | USPAT; US-PGPUB; EPO; | 1/11/29 | *************************************** | |
| 13 | 3 BRS | 4 | sive) | JPO; DERWENT; IBM TDB | | | |
| 14 | 4 BRS | 112 | or die) and (dhesive) | USFAT; US-FGFUB; EFO; JPO; DERWENT; IBM TDB | 2001/11/29 13:59 | | |
| 7. | 5 BRS | 17 | ((chip or die) and ((bismaleimide or bt or | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 1/11/29 14:0 | | |
| <u> </u> | \neg | | | 1 F 4 | 2001/11/29 14:13 | *************************************** | |
| 1 L0 | O LS&K | 7 | ((solder adj mask) with outgas\$) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/29 14:18 | | |
| . 6 | | 15829 | cure with adhesive | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/29 15:54 | | |
| 1 | | | | | | | |

| | | | | | | | Error |
|---|---|---|--|-------------------------------|------------------|----------|---|
| | Type | Hits | Search Text | DBs | Time Stamp | Comments | Definition |
| | -37- | | | HEDDAT HE-PEPHR: FPO: | | | |
| | BRS | 195 | adhesive with outgassing | JPO; DERWENT; IBM TDB | 1/11/28 18:44 | | |
| | *************************************** | *************************************** | | HSPAT: US-PGPUB; EPO; | ••••• | | .,, |
| 2 | BRS | က | ((solder adj mask) with out\$1gass\$3) | JPO; DERWENT; IBM TDB | TC:01 87/11/1007 | | |
| l | | | | TO DE LE PORTE DO LA PROCESTA | | | |
| m | BRS | 165 | solder same out\$1gass\$3 | JPO; DERWENT; IBM TDB | | | |
| | | | | TICONT. TIC-DCDIIR. FDO: | | | |
| 4 | BRS | 10 | out\$1gass\$3) | JPO; DERWENT; IBM TDB | 1/11/28 18:52 | | |
| | 000000000000000000000000000000000000000 | | *************************************** | Hebat. HS-PGPHB: EPO: | | ****** | ***** |
| 2 | BRS | 73 | (solder same out\$1gass\$3) and adhesive | JPO; DERWENT; IBM TDB | 2001/11/28 19:21 | | |
| | | | | HCDAT. HC-PCPIIB: F.PO: | | | *************************************** |
| 9 | BRS | 24 | (solder with out\$1gass\$3) and adhesive | JPO; DERWENT; IBM TDB | 2001/11/28 19:22 | | |
| | | | | | | | |